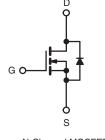




## **E Series Power MOSFET**

PRODUCT SUMMARY						
V <sub>DS</sub> (V) at T <sub>J</sub> max.	700					
R <sub>DS(on)</sub> max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.145				
Q <sub>g</sub> max. (nC)	122					
Q <sub>gs</sub> (nC)	21					
Q <sub>gd</sub> (nC)	37					
Configuration	Single					





N-Channel MOSFET

#### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>q</sub>)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION				
Package	D <sup>2</sup> PAK (TO-263)			
	SiHB24N65E-GE3			
Lead (Pb)-free and Halogen-free	SiHB24N65ET1-GE3			
	SiHB24N65ET5-GE3			

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> :	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	V <sub>DS</sub>	650	V		
Gate-Source Voltage	V <sub>GS</sub>	± 30	v		
Continuous Drain Current (T <sub>1</sub> = 150 °C)	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C		24	
Continuous Drain Current $(I_J = 150 \text{ C})$	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	ID	16	A
Pulsed Drain Current <sup>a</sup>		I <sub>DM</sub>	70		
Linear Derating Factor		2	W/°C		
Single Pulse Avalanche Energy <sup>b</sup>		E <sub>AS</sub>	508	mJ	
Maximum Power Dissipation	PD	250	W		
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		
Drain-Source Voltage Slope	-1) (/-1+	37			
Reverse Diode dV/dt <sup>d</sup>		dV/dt	11	V/ns	
Soldering Recommendations (Peak Temperature) <sup>c</sup>		300	°C		

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b.  $V_{DD}$  = 50 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>q</sub> = 25  $\Omega$ , I<sub>AS</sub> = 6 A.

c. 1.6 mm from case.

d.  $I_{SD} \leq I_D$ , dl/dt = 100 A/µs, starting  $T_J$  = 25 °C.

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RoHS

COMPLIANT HALOGEN

FREE



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PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-		62				
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-		0.5		°C/W		
	place otherw	ice poted)						
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, u PARAMETER	SYMBOL		T CONDIT		MIN.	TYP.	MAX.	
Static	STINDOL	123			IVIIIA.		WAA.	UNI
Drain-Source Breakdown Voltage	V <sub>DS</sub>	No.	= 0 V, I <sub>D</sub> =	250	650	-	-	V
-	-			•	050	- 0.72	-	-
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$			<sub>D</sub> = 250 μA	-	-		V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	-	= V <sub>GS</sub> , I <sub>D</sub> =		2	-	4	V
Gate-Source Leakage	I <sub>GSS</sub>		$V_{GS} = \pm 20$		-	-	± 100	nA
	000		$V_{GS} = \pm 30$		-	-	± 1	μA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =	$V_{DS} = 650 \text{ V}, V_{GS} = 0 \text{ V}$			-	1	μA
Zero date Voltage Drain Garront	<sup>1</sup> DSS	V <sub>DS</sub> = 520 V	/, V <sub>GS</sub> = 0 \	/, T <sub>J</sub> = 125 °C	-	-	10	μ.,
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I	<sub>D</sub> = 12 A	-	0.120	0.145	Ω
Forward Transconductance	<b>g</b> fs	V <sub>D</sub>	<sub>S</sub> = 8 V, I <sub>D</sub>	= 5 A	-	7.1	-	S
Dynamic		•						
Input Capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V	,	-	2740	-	-
Output Capacitance	Coss		$V_{DS} = 100$		-	122	-	
Reverse Transfer Capacitance	C <sub>rss</sub>		f = 1 MH	2	-	4	-	
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>		$V_{DS} = 0 V$ to 520 V, $V_{GS} = 0 V$		-	93	-	pF
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>	- V <sub>DS</sub> = 0 V			-	352	-	
Total Gate Charge	Qg				-	81	122	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 12	A, V <sub>DS</sub> = 520 V	-	21	-	
Gate-Drain Charge	Q <sub>gd</sub>				-	37	-	
Turn-On Delay Time	t <sub>d(on)</sub>				-	24	48	
Rise Time	t <sub>r</sub>		= 520 V, I <sub>D</sub>	- 12 Δ	-	84	126	
Turn-Off Delay Time	t <sub>d(off)</sub>		= 10 V, Rg =		-	70	105	ns
Fall Time	t <sub>f</sub>			-	69	104	1	
Gate Input Resistance	Rg	f = 1	MHz, ope	n drain	-	0.68	-	Ω
Drain-Source Body Diode Characteristic								
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	MOSFET sym showing the	bol		-	-	24	
Pulsed Diode Forward Current	I <sub>SM</sub>	integral revers	integral reverse p - n junction diode		-	-	70	- A
Diode Forward Voltage	V <sub>SD</sub>	T <sub>.1</sub> = 25 °C	C, I <sub>S</sub> = 12 A	A, V <sub>GS</sub> = 0 V	-	-	1.2	V
Reverse Recovery Time	t <sub>rr</sub>		, , , ,		-	433	-	ns
Reverse Recovery Charge	Q <sub>rr</sub>	T <sub>J</sub> = 2	5 °C, I <sub>F</sub> = I	<sub>6</sub> = 12 A,	-	7.3	-	μC
	Urr	dl/dt = 100 A/µs, V <sub>R</sub> = 25 V			1 1.0		ι μυ	

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ . b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

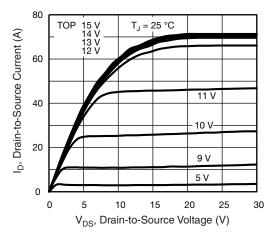


Fig. 1 - Typical Output Characteristics

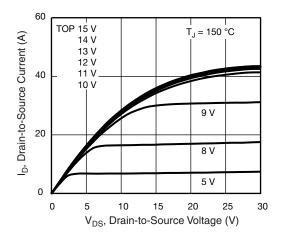
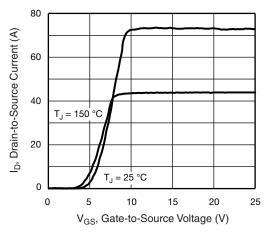


Fig. 1 - Typical Output Characteristics





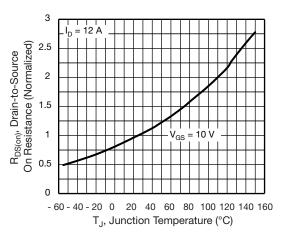


Fig. 3 - Normalized On-Resistance vs. Temperature

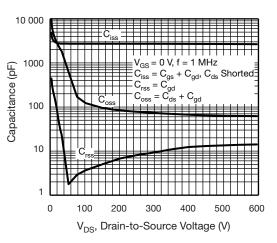
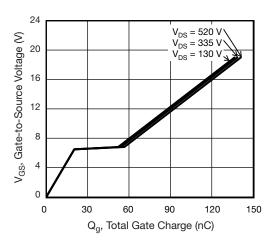
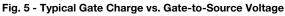


Fig. 4 - Typical Capacitance vs. Drain-to-Source Voltage





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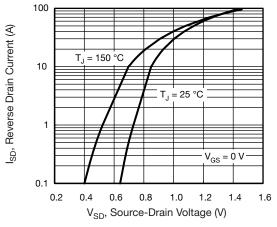


Fig. 6 - Typical Source-Drain Diode Forward Voltage

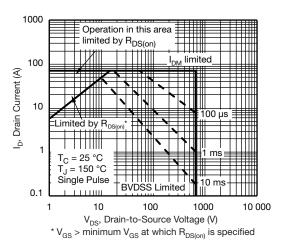


Fig. 7 - Maximum Safe Operating Area

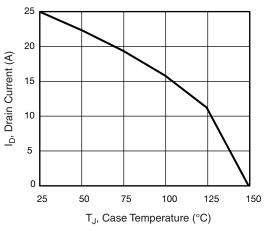


Fig. 8 - Maximum Drain Current vs. Case Temperature

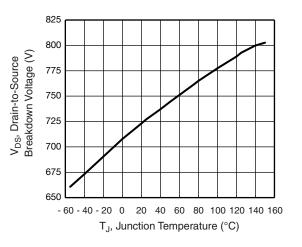
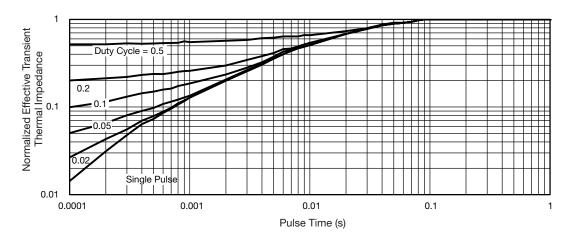


Fig. 9 - Temperature vs. Drain-to-Source Voltage





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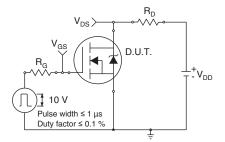


Fig. 11 - Switching Time Test Circuit

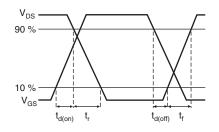


Fig. 12 - Switching Time Waveforms

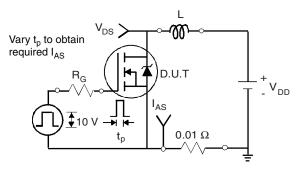


Fig. 13 - Unclamped Inductive Test Circuit

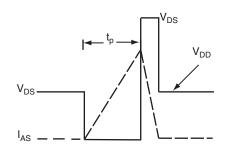


Fig. 14 - Unclamped Inductive Waveforms

10 V  $Q_{G}$   $Q_{G}$ 

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Fig. 15 - Basic Gate Charge Waveform

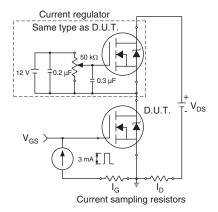


Fig. 16 - Gate Charge Test Circuit

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#### Peak Diode Recovery dV/dt Test Circuit

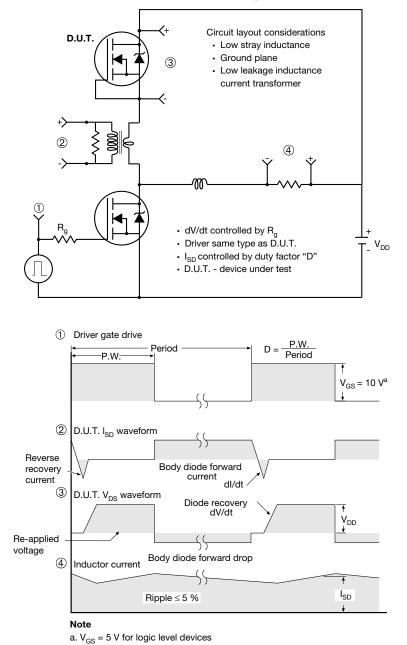


Fig. 17 - For N-Channel

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H

A1

B

Gauge plane

L3

Detail "A" Rotated 90° CW scale 8:1

0° to 8° **Vishay Siliconix** 

Seating plane

### **TO-263AB (HIGH VOLTAGE)**

/3 ⁄4 A

н

∕₅∖

Detail A

(Datum A)

D

 $\underline{4}$ 11

	2	-	Y 2 x b2 2 x b ⊕ 0.010 @ A(	■ ating 5 b1, b b1, b b1, b c) c) c) c) c) c) c) c) c) c)	$\begin{array}{c} c_{1} \\ c_{1} \\ c_{2} \\ c_{3} \\ c_{4} \\ c_{5} \\ c_{7} \\$	<b>a</b> - 1		Ū.	1 <u>4</u>	
	MILLIN	IETERS	INC	INCHES			MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.		DIM.	MIN.	MAX.	MIN.	MAX.
А	4.06	4.83	0.160	0.190		D1	6.86	-	0.270	-
				0.010		-		10.07	0.000	0.420
A1	0.00	0.25	0.000	0.010		E	9.65	10.67	0.380	0.120
A1 b	0.00 0.51	0.25 0.99	0.000	0.010		E1	9.65 6.22	- 10.67	0.380	-
							6.22	- 10.67 - BSC	0.245	- BSC
b	0.51	0.99	0.020	0.039		E1	6.22	-	0.245	-
b b1	0.51 0.51	0.99 0.89	0.020 0.020	0.039 0.035		E1 e	6.22 2.54	- BSC	0.245	- ) BSC
b b1 b2	0.51 0.51 1.14	0.99 0.89 1.78	0.020 0.020 0.045	0.039 0.035 0.070		E1 e H	6.22 2.54 14.61	- BSC 15.88	0.245 0.100 0.575	- ) BSC 0.625
b b1 b2 b3	0.51 0.51 1.14 1.14	0.99 0.89 1.78 1.73	0.020 0.020 0.045 0.045	0.039 0.035 0.070 0.068		E1 e H L	6.22 2.54 14.61 1.78	- BSC 15.88 2.79	0.245 0.100 0.575 0.070	- 0 BSC 0.625 0.110
b b1 b2 b3 c	0.51 0.51 1.14 1.14 0.38	0.99 0.89 1.78 1.73 0.74	0.020 0.020 0.045 0.045 0.015	0.039 0.035 0.070 0.068 0.029		E1 e H L L1	6.22 2.54 14.61 1.78 - -	- BSC 15.88 2.79 1.65	0.245 0.100 0.575 0.070 - -	- 0 BSC 0.625 0.110 0.066
b b1 b2 b3 c c1	0.51 0.51 1.14 1.14 0.38 0.38	0.99 0.89 1.78 1.73 0.74 0.58	0.020 0.020 0.045 0.045 0.015 0.015	0.039 0.035 0.070 0.068 0.029 0.023		E1 e H L L1 L2	6.22 2.54 14.61 1.78 - -	- BSC 15.88 2.79 1.65 1.78	0.245 0.100 0.575 0.070 - -	- 0 BSC 0.625 0.110 0.066 0.070

Α

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Dimensions are shown in millimeters (inches).

3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.

4. Thermal PAD contour optional within dimension E, L1, D1 and E1.

5. Dimension b1 and c1 apply to base metal only.

6. Datum A and B to be determined at datum plane H.

7. Outline conforms to JEDEC outline to TO-263AB.



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### **RECOMMENDED MINIMUM PADS FOR D<sup>2</sup>PAK: 3-Lead**



Recommended Minimum Pads Dimensions in Inches/(mm)

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